VS-HFA90NH40PbF

Vishay Semiconductors

HEXFRED[®] Ultrafast Soft Recovery Diode, 210 A



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HALF-PAK (D-67)

PRODUCT SUMMARY				
I _F (maximum)	210 A			
V _R	400 V			
I _{F(DC)} at T _C	106 A at 100 °C			
Package	HALF-PAK (D-67)			
Circuit	Single diode			

FEATURES

- Very low Q_{rr} and t_{rr}
- Designed and qualified for industrial level
- UL approved file E222165
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

BENEFITS

- Reduced RFI and EMI
- Reduced snubbing

DESCRIPTION

HEXFRED[®] diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems. An extensive characterization of the recovery behavior for different values of current, temperature and dl_F/dt simplifies the calculations of losses in the operating conditions. The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for power converters, motors drives and other applications where switching losses are significant portion of the total losses.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	SYMBOL TEST CONDITIONS		UNITS	
Cathode to anode voltage	V _R		400	V	
Continuous forward current		T _C = 25 °C	210		
Continuous forward current	IF	T _C = 100 °C	106	А	
Single pulse forward current	I _{FSM}	Limited by junction temperature	600		
Non-repetitive avalanche energy	E _{AS}	L = 100 $\mu H,$ duty cycle limited by maximum $T_{\rm J}$	1.4	mJ	
Maximum power dissipation P _D		$T_{C} = 25 \ ^{\circ}C$	329	w	
		T _C = 100 °C	132		
Operating junction and storage temperature range	T _J , T _{Stg}		-55 to +150	°C	

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V _{BR}	I _R = 100 μA		400	-	-	
		I _F = 90 A		-	1.06	1.45	v
Maximum forward voltage	aximum forward voltage V _{FM}	I _F = 180 A	See fig. 1	-	1.2	1.67	
		$I_F = 90 \text{ A}, \text{T}_\text{J} = 125 \ ^\circ\text{C}$	-		0.96	1.23	
Maximum reverse leakage current	I _{RM}	$T_{J} = 125 \text{ °C}, V_{R} = 400 \text{ V}$	See fig. 2	-	0.6	2	mA
Junction capacitance	CT	V _R = 200 V See fig. 3		-	180	260	pF
Series inductance	L _S	From top of terminal hole to mounting plane - 7.0 -		nH			

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DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 $^{\circ}$ C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS		
Reverse recovery time	+	T _J = 25 °C		-	90	140	ns	
See fig. 5	۲r	T _J = 125 °C		-	158	240	115	
Peak recovery current	I _{RRM}	T _J = 25 °C	I _F = 90 A dI _F /dt = 200 A/µs V _R = 200 V	-	9	17	А	
See fig. 6		T _J = 125 °C		-	15	30		
Reverse recovery charge	Q _{rr}	T _J = 25 °C		-	420	1100	nC	
See fig. 7		T _J = 125 °C		-	1200	3200	no	
Peak rate of recovery current See fig. 8	dl (dt	dl /dt	T _J = 25 °C		-	370	-	A /u o
	dl _{(rec)M} /dt	T _J = 125 °C		-	270	-	A∕µs	

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction and storage temperature range		T _J , T _{Stg}		-55 to 150	°C	
Maximum thermal resistance, junction to caseR thJCDC operation See fig. 4		0.38	°C/W			
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, flat, smooth and greased	0.05		
				30	g	
Approximate weight				1.06	oz.	
Mounting torque	minimum		Non-lubricated threads	3 (26.5)		
Mounting torque	maximum			4 (35.4)	N ⋅ m	
Terminal torgue	minimum			3.4 (30)	(lbf · in)	
reminartorque	maximum			5 (44.2)	7	
Case style			HALF-PAK module			

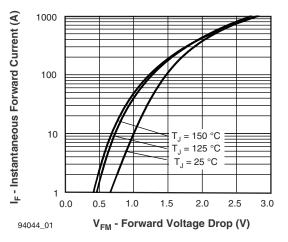
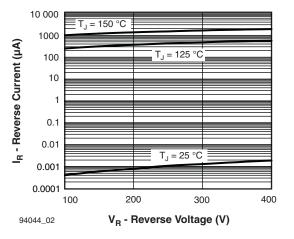
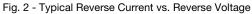


Fig. 1 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

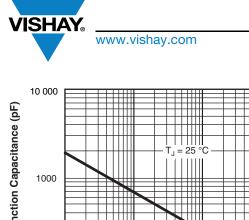




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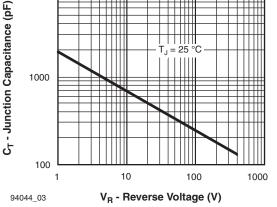


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

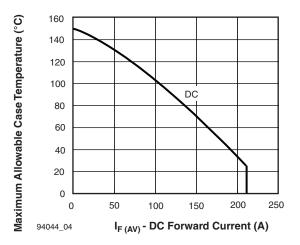


Fig. 4 - Maximum Allowable Case Temperature vs. **DC Forward Current**

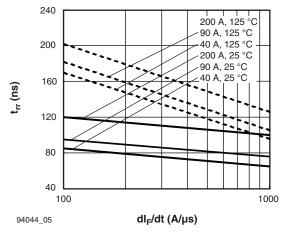


Fig. 5 - Typical Reverse Recovery Time vs. dl_F/dt

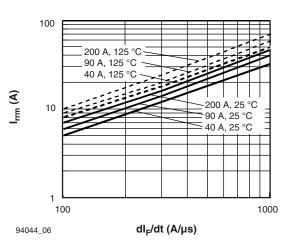
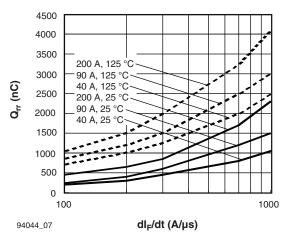
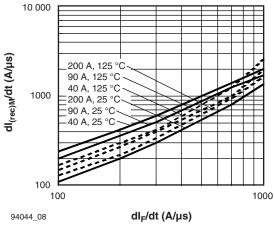


Fig. 6 - Typical Recovery Current vs. dl_F/dt









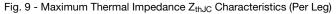
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www.vishay.com 1 Z_{thJC} - Thermal Response 0.1 D = 0.50[∠]D = 0.33[·] ΠT D = 0.25 T | | | | D = 0.17 0.01 Single pulse ED = 0.08 (thermal response) 0.001 0.00001 0.0001 0.001 0.01 0.1 1 10 94044_09 t₁ - Rectangular Pulse Duration (s)



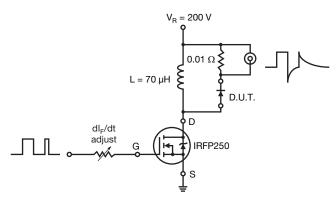
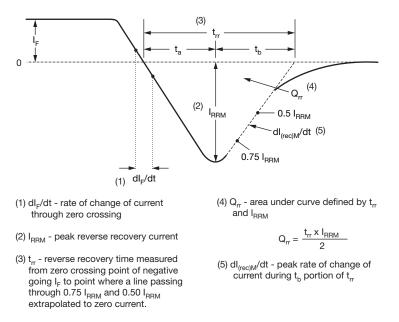
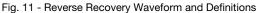


Fig. 10 - Reverse Recovery Parameter Test Circuit





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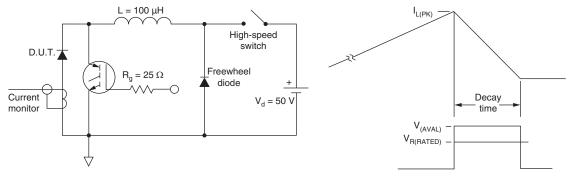
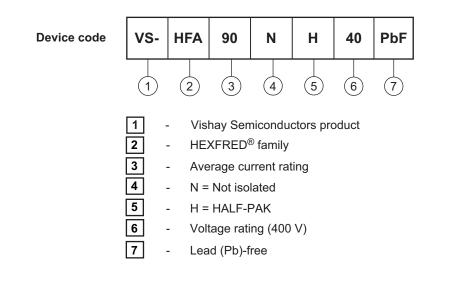


Fig. 12 - Avalanche Test Circuit and Waveforms

ORDERING INFORMATION TABLE



LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95020			

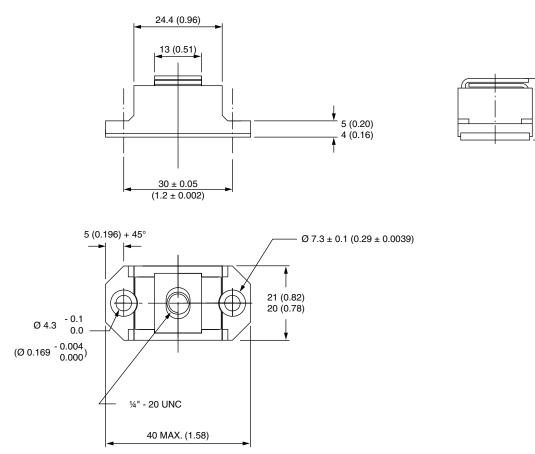
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17.5 (0.69) 16.5 (0.65)



DIMENSIONS in millimeters (inches)

SHAY





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